

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:		NEW ASSIGNMENT
NATURE OF CONVEYANCE:		ASSIGNMENT
CONVEYING PARTY DATA		
Name		Execution Date
John R. Tuttle		01/11/2006
RECEIVING PARTY DATA		
Name:	DayStar Technologies, Inc.	
Street Address:	13 Corporate Drive	
City:	Halfmoon	
State/Country:	NEW YORK	
Postal Code:	12065	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11272386	
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ATTORNEY DOCKET NUMBER:	3015104 US01	
NAME OF SUBMITTER:	Andrew H. Yost	
Total Attachments: 1 source=3015104 US01#page1.tif		

CH \$40.00 11272386

ASSIGNMENT

WHEREAS, **John R. Tuttle**, residing at 88 Knapp Road, Mechanicville, NY 12118 (hereinafter "Assignor") invented certain new and useful improvements in **THERMAL PROCESS FOR CREATION OF AN IN-SITU JUNCTION LAYER IN CIGS** (hereinafter "Invention"), for which Assignor, on November 10, 2005, filed with the United States Patent and Trademark Office an application for United States Letters Patent, Application number 11/272,386, (hereinafter "Application"); and


WHEREAS, DayStar Technologies, Inc., of 13 Corporate Drive, Halfmoon, NY 12065 (hereinafter "Assignee") is desirous of obtaining Assignor's entire right, title and interest in, to and under said Invention and Application;

NOW, THEREFORE, in consideration of ten dollars paid to Assignor and other good and valuable consideration, the receipt of which is hereby acknowledged, Assignor has sold, assigned and transferred, and by these presents does hereby sell, transfer and assign to Assignee, Assignee's successors, legal representatives or assigns, Assignor's entire right, title and interest in, to and under said Invention and Application, all U.S. Applications claiming priority and/or disclosing the invention of the Application, and any and all divisions, continuations and continuations-in-part of thereof, all priority rights therein, all Letters Patent which may be granted thereon and all renewals and extensions thereof, all applications for Letters Patent which may be filed thereon in every country or countries other than the United States and all Letters Patent which may be granted thereon by such other country or countries and all renewals and extensions thereof. Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States, and any Official of any other such country or countries whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent therefor to Assignee, Assignee's successors, legal representatives or assigns as provided by this instrument.

Assignor covenants and warrants that Assignor has the full right and power to convey the entire interest herein assigned, and that Assignor has not executed and shall not hereafter execute any document in conflict with this assignment or constituting a lien against or right under the subject matter assigned. Assignor further covenants and agrees to communicate to Assignee, Assignee's successors, legal representatives or assigns, any facts known to Assignor respecting said Invention, to testify in any proceedings, to sign all lawful papers, and to execute all applications for patent and other documents and generally to do everything possible to aid Assignee, Assignee's successors, legal representatives or assigns to obtain and enforce any and all Letters Patent for said Invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 11th day of January, 2006.

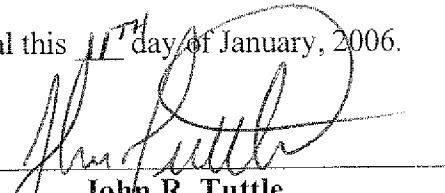
Witness:


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